

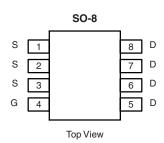
# N-Channel 80-V (D-S) MOSFET

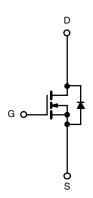
PRODUCT SUMMARY				
V <sub>DS</sub> (V)	$R_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A)		
80	0.0165 at V <sub>GS</sub> = 10 V	9.5		
	0.0220 at V <sub>GS</sub> = 6.0 V	8.3		

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFETs
- Compliant to RoHS Directive 2002/95/EC







N-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b>	T <sub>A</sub> = 25 °C, unles	ss otherwise r	noted		
Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		V <sub>DS</sub>	80		V
Gate-Source Voltage		V <sub>GS</sub>	± 20		V
Continuous Dunin Comment /T 150 90\8	T <sub>A</sub> = 25 °C	I <sub>D</sub>	9.5	6.7	
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a</sup>	T <sub>A</sub> = 70 °C		7.6	5.4	
Pulsed Drain Current		I <sub>DM</sub>	50		Α
Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	40		
Continuous Source Current (Diode Conduction) <sup>a</sup>		I <sub>S</sub>	2.8	1.4	
	T <sub>A</sub> = 25 °C	D	3.1	1.56	W
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 70 °C	$P_{D}$	2.0	1.0	VV
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 1	to 150	°C

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Typical	Maximum	Unit	
Manimum Innation to Ambient	t ≤ 10 s	R <sub>thJA</sub>	33	40	
Maximum Junction-to-Ambient <sup>a</sup>	Steady State	' 'thJA	65	80	°C/W
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	17	21	

#### Notes

a. Surface Mounted on 1" x 1" FR4 board.

服务热线:400-655-8788

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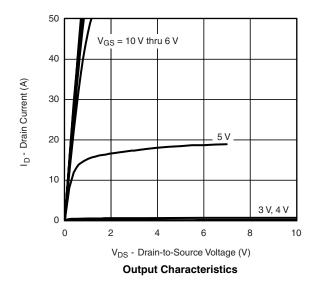
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.5		3	V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zava Cata Valtaga Drain Current		V <sub>DS</sub> = 64 V, V <sub>GS</sub> = 0 V			1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 64 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			5	μΑ	
On-State Drain Current <sup>a</sup>	Drain Current <sup>a</sup> I <sub>D(on)</sub>		50			Α	
	В	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A	0.0	0.0165		Ω	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 6.0 \text{ V}, I_D = 8.0 \text{ A}$		0.0220			
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 10 A		20		S	
Diode Forward Voltage <sup>a</sup>	$V_{SD}$	$I_S = 2.8 \text{ A}, V_{GS} = 0 \text{ V}$		0.75	1.1	V	
Dynamic <sup>b</sup>	<u> </u>		•	•			
Total Gate Charge	$Q_g$			34	41		
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 40 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$		7.5		nC	
Gate-Drain Charge	$Q_{gd}$			11.0		1	
Gate Resistance	$R_{g}$		0.2	0.85	1.2	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			17	25		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 40 V, $R_L$ = 40 $\Omega$		11	17	1	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 1.0 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 6 \Omega$		40	60	ns	
Fall Time	t <sub>f</sub>			31	45		
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 2.8 A, dI/dt = 100 A/μs		45	75		

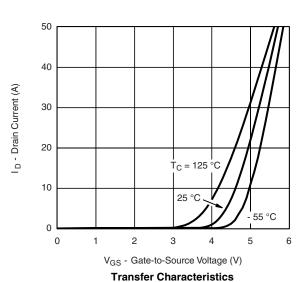
#### Notes:

- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

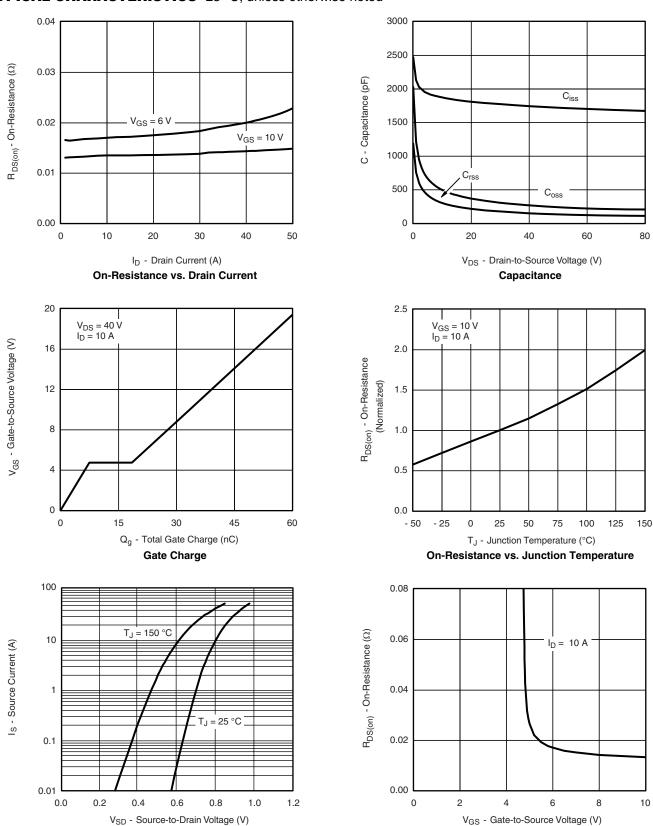
### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted







#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

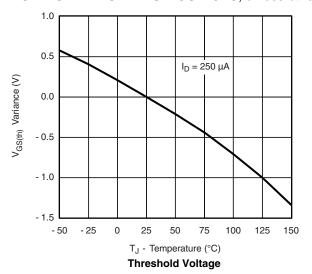


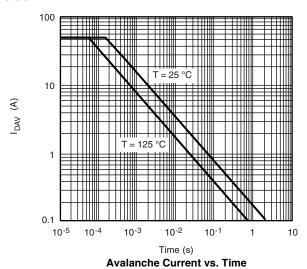
Source-Drain Diode Forward Voltage

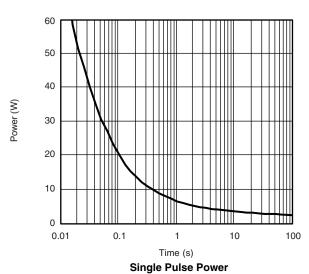
On-Resistance vs. Gate-to-Source Voltage

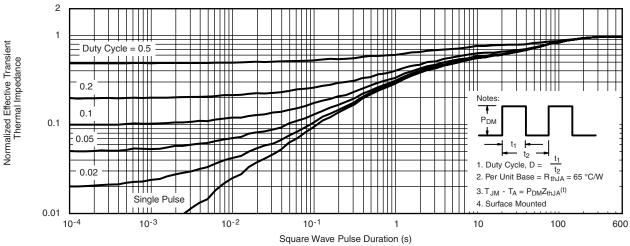


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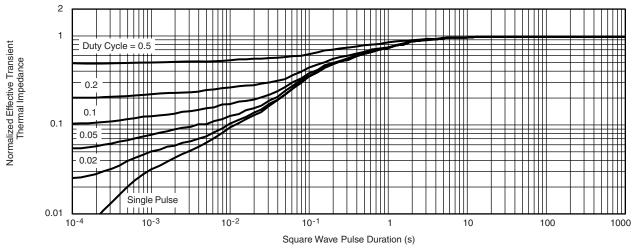




Normalized Thermal Transient Impedance, Junction-to-Ambient



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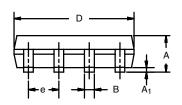


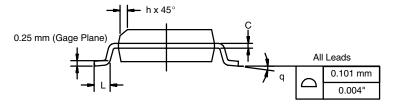
Normalized Thermal Transient Impedance, Junction-to-Foot



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





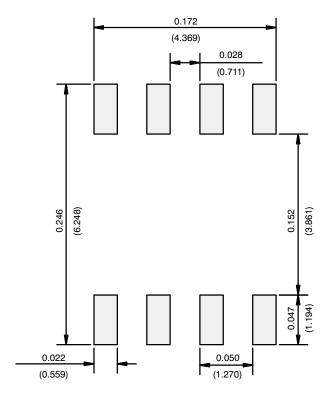


	MILLIM	IETERS	INC	HES		
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06						

DWG: 5498



### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)



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